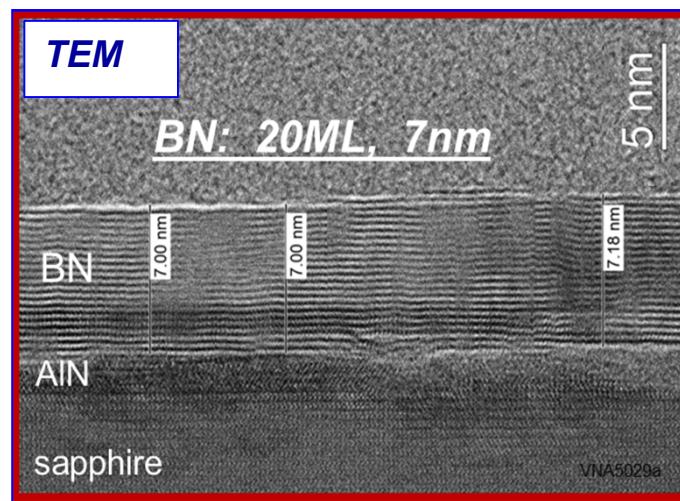
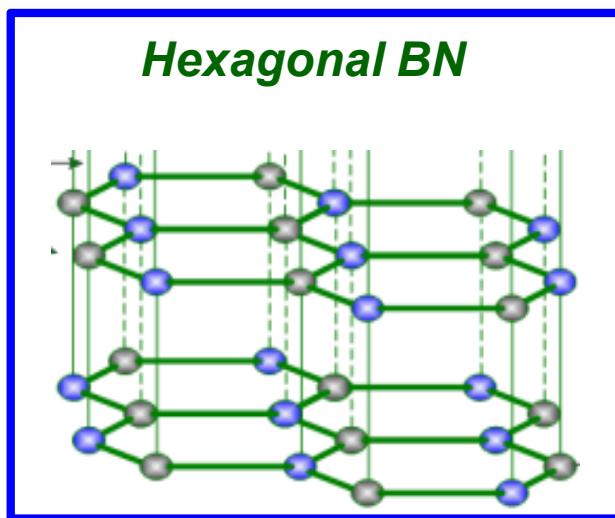


Excitonic Properties of Hexagonal BN Grown by High-Temperature Metal-organic Vapor Phase Epitaxy

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Outline

- Evolution of excitonic properties vs. MOVPE growth temperature
- Epitaxial growth as an approach to high-quality few-ML-thick hBN films

1. INTRODUCTION

- a) Background and motivation
- b) Excitonic properties

2. EPITAXIAL GROWTH AND CHARACTERIZATION OF hBN

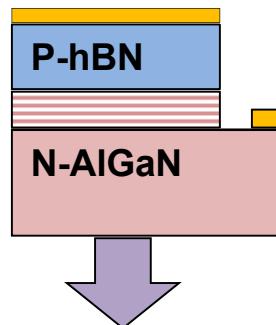
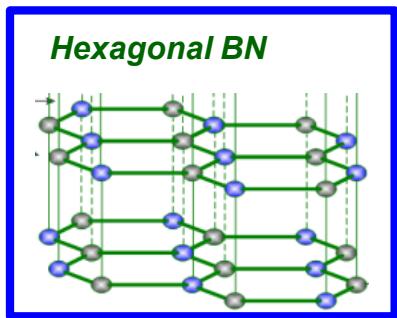
- a) MOVPE Growth at $\leq 1200^{\circ}\text{C}$
 - Pulsed growth conditions
 - Structural and optical properties
- b) MOVPE Growth at $1200 - 1700^{\circ}\text{C}$
 - Excitonic properties vs. growth temperature
 - Growth control to the monolayer limit
 - Alternative substrates to sapphire

3. SUMMARY

Background

Motivation

- Ideal template for high-mobility graphene
- Very wide bandgap 2D material (deep UV)
- Demonstrated p-type doping
- $\sim > 10$ x exciton binding energy of GaN

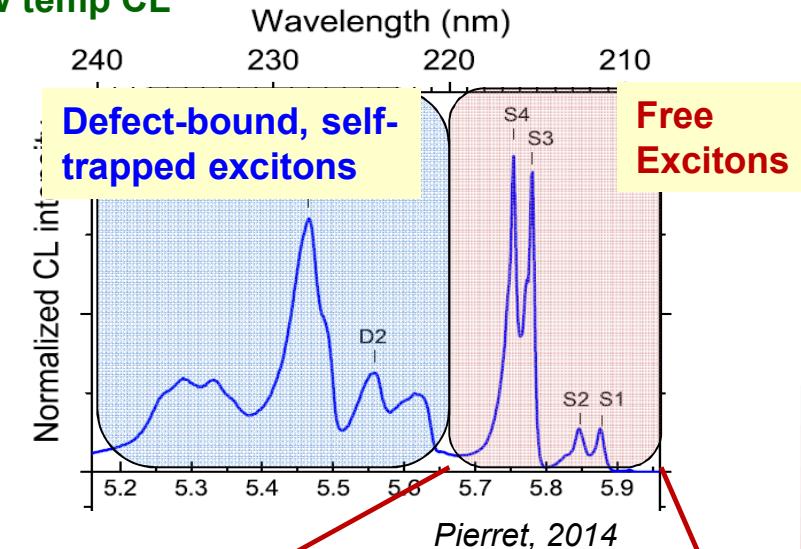


Outstanding Questions:

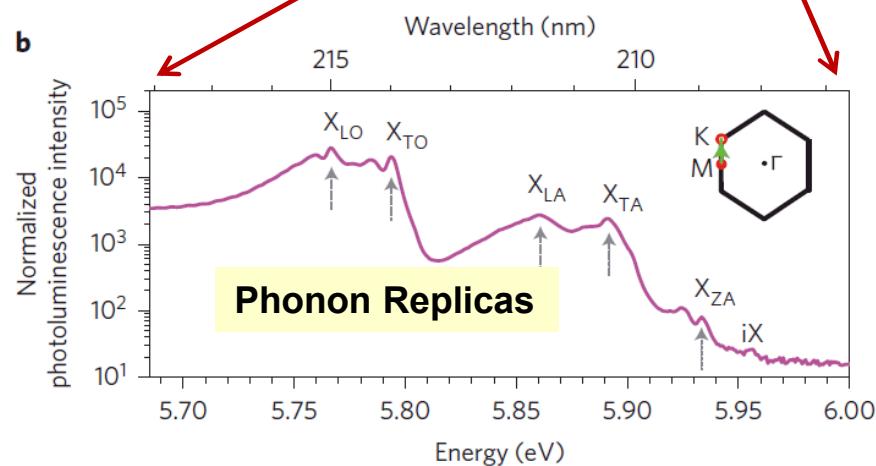
- Nature of the bandgap (indirect or direct)
- Excitonic properties (binding energy ~ 0.13 - 0.75 eV, Wannier vs. Frenkel)
- Origins of near-band-edge luminescence (free/bound excitons vs. phonon replicas)

Excitonic Properties

Low temp CL



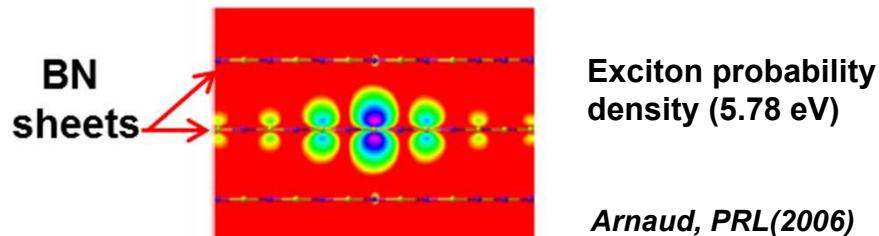
b



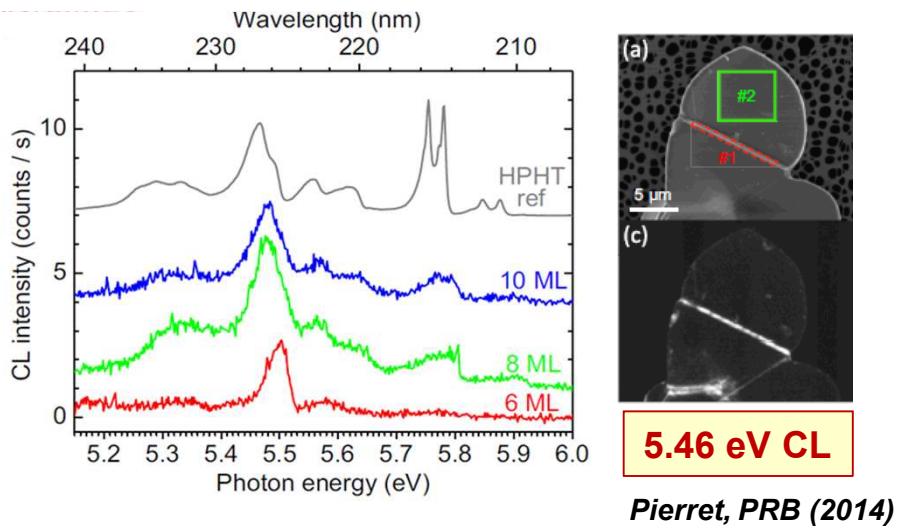
Excitonic Properties at Few-Monolayer Thickness

Question: How do the excitonic properties of hBN evolve with thickness down to 1 ML?

Strong Exciton Confinement

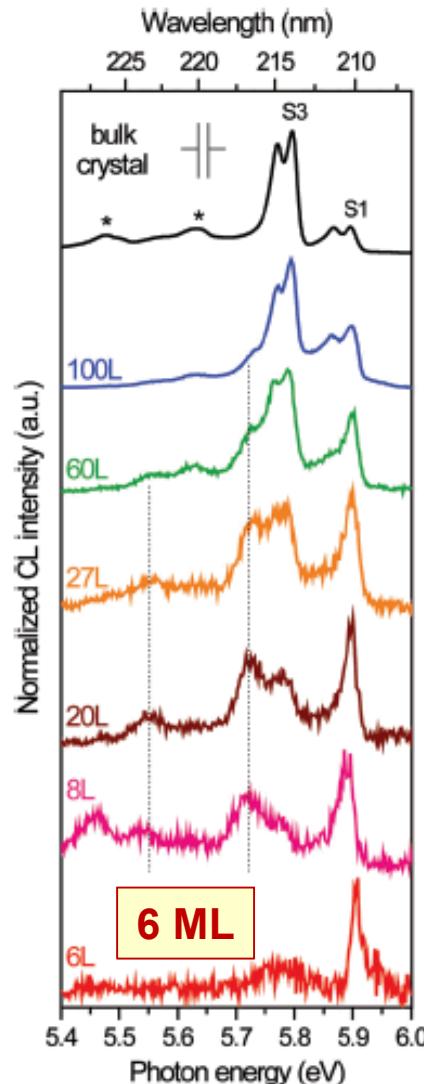


Low Temp. CL: Exfoliated hBN flakes



Loss of higher energy, free-exciton related features with exfoliation

Low Temp CL: Exfoliated hBN Flakes

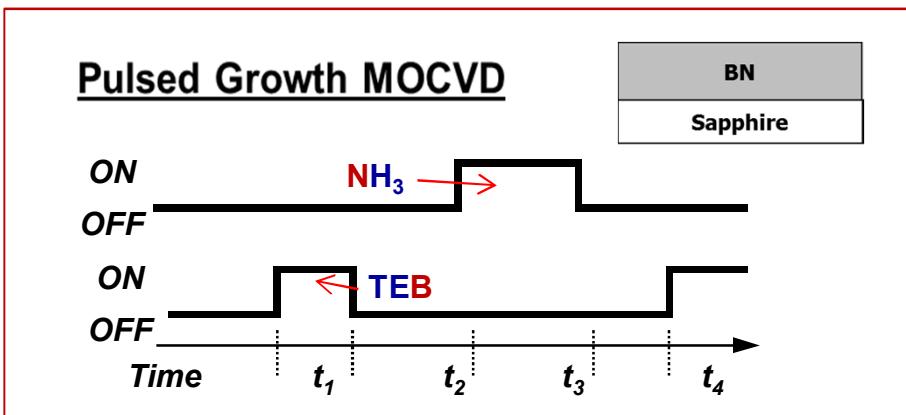


Improved Exfoliation: excitonic evolution down to 6 ML

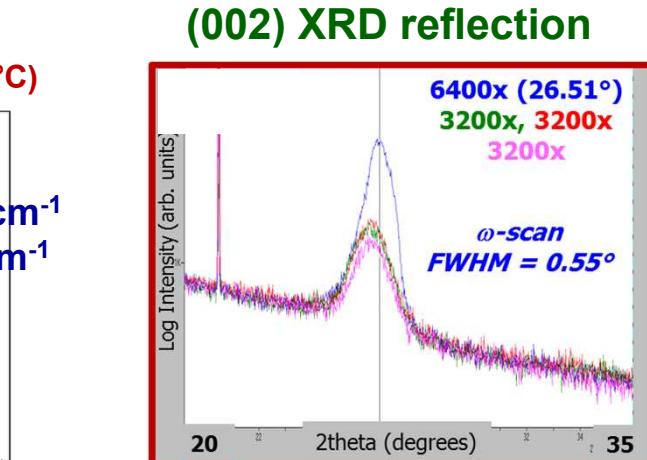
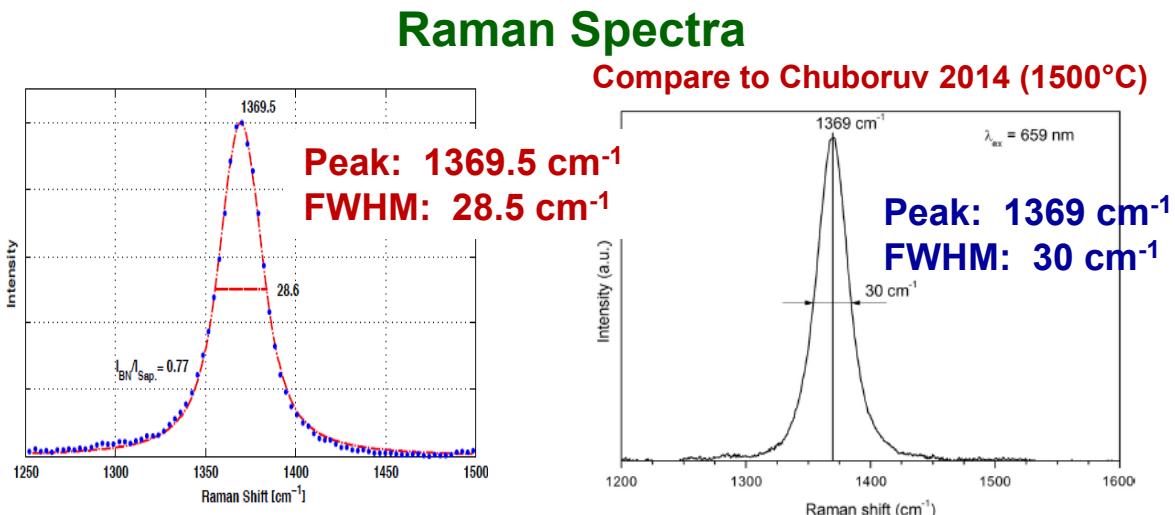
→ Explore epitaxial growth approaches

MOVPE Growth ($T_g \sim 1175^\circ\text{C}$)

- **Continuous growth:** high growth rate at low V/III but poor crystalline quality
- **Pulsed growth** chosen to enable higher V/III ratios for improved film quality

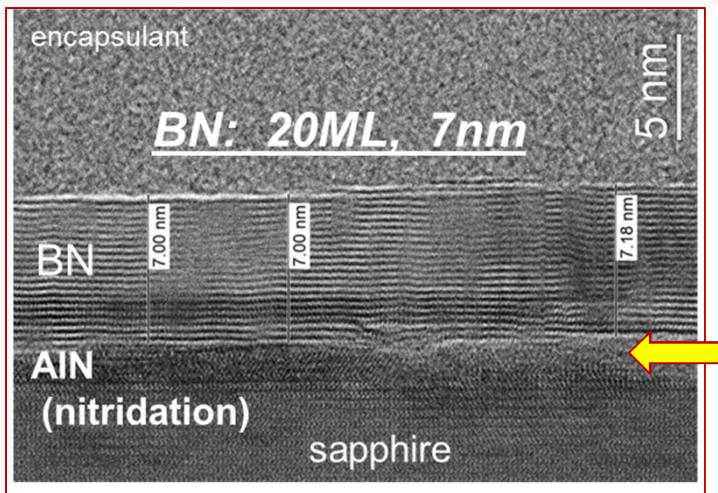


Growth Condition	Parameter Range
Temperature	1175°C
Pressure	50-200 Torr
NH_3 Flow	0.2-10 slm
TEB Flow	3-12 $\mu\text{moles}/\text{min}$
Pulse Cycles	20-9600
Time per Cycle	1-12 sec

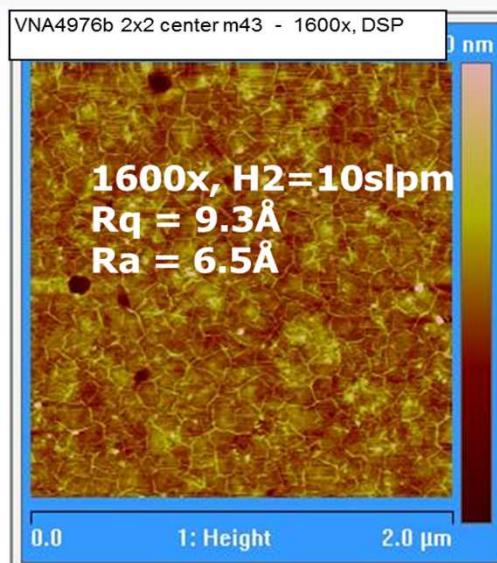


Structure and Morphology of hBN ($T_g \sim 1175^\circ\text{C}$)

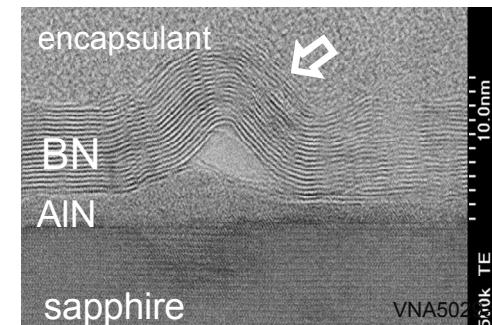
High-resolution cross-section TEM



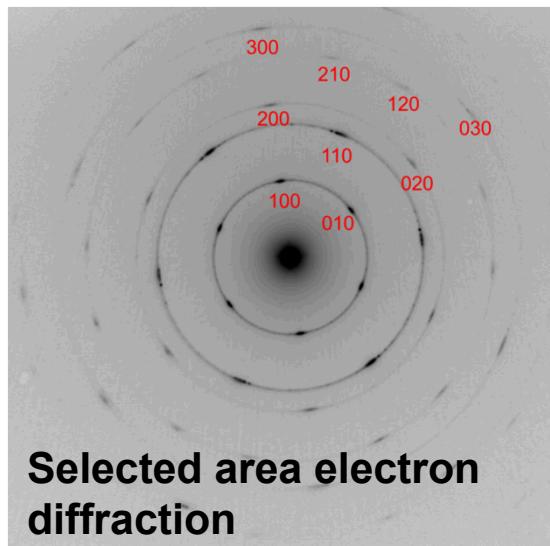
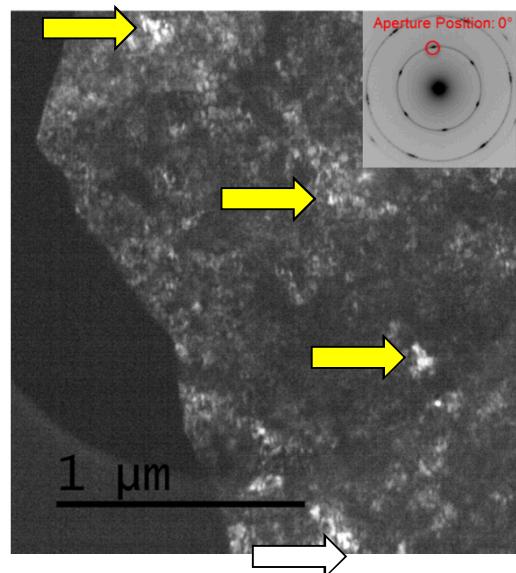
AFM



- Typical “wrinkles”
- Also particles forming on surface with increasing thickness



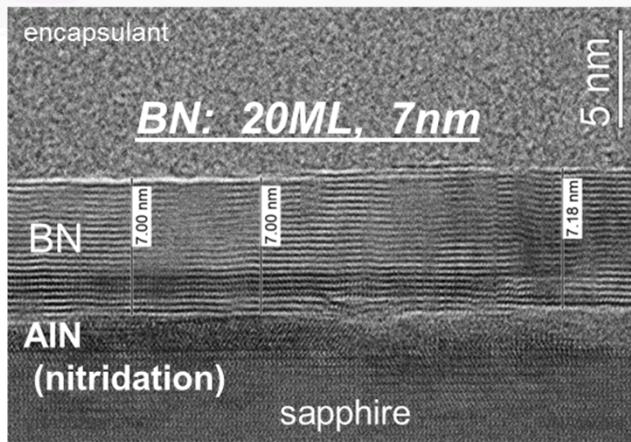
TEM (dark-field) free-standing BN



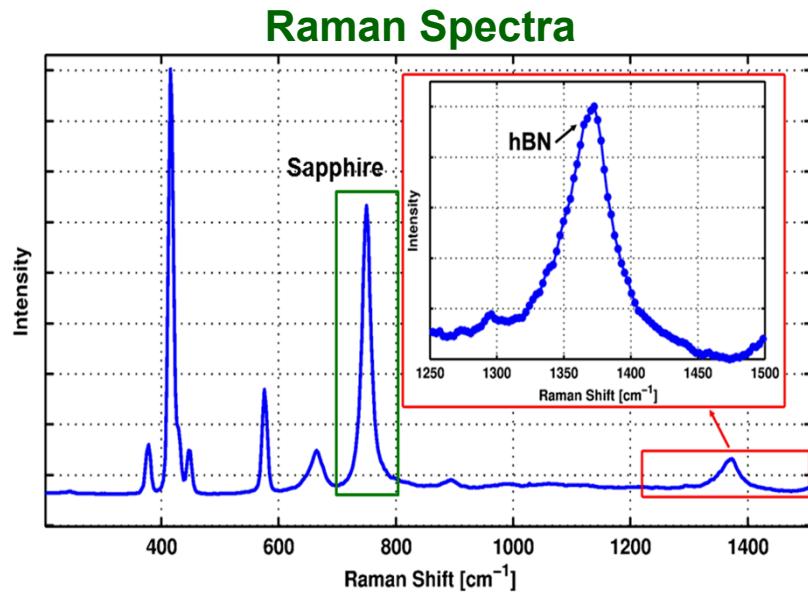
- Bright regions indicate strong in-plane alignment
- $hk0$ rings indicate in-plane rotation disorder
- $hk0$ reflection spots indicate basal plane alignment

Estimation of Film thicknesses

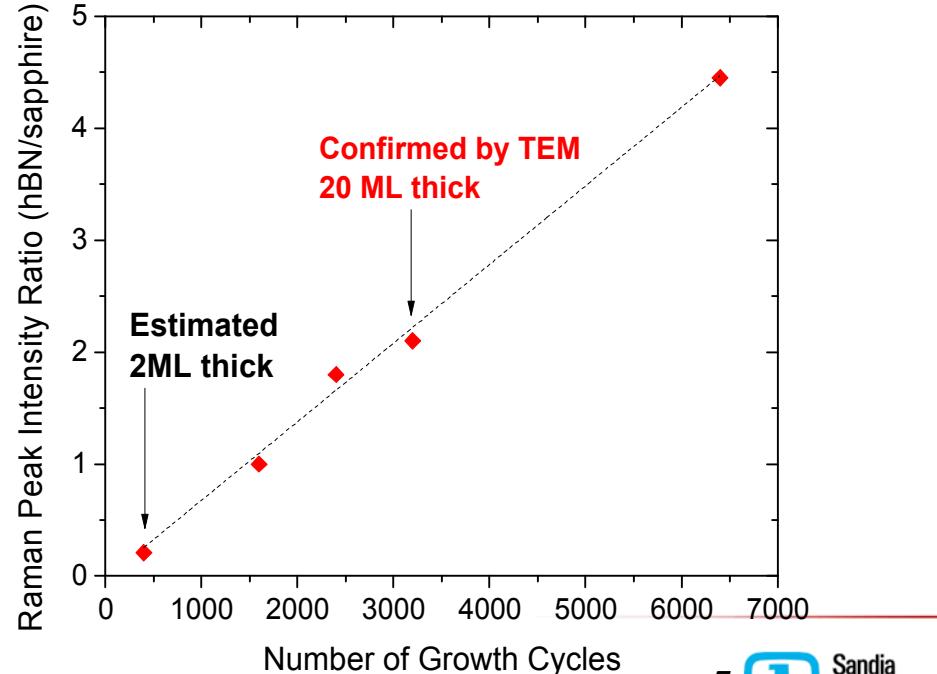
Cross-sectional TEM



- Difficulty seeing very thin layers by TEM
- Using hBN/sapphire Raman intensity ratio as a rough estimate
- Suggests reproducible 1-3 ML control

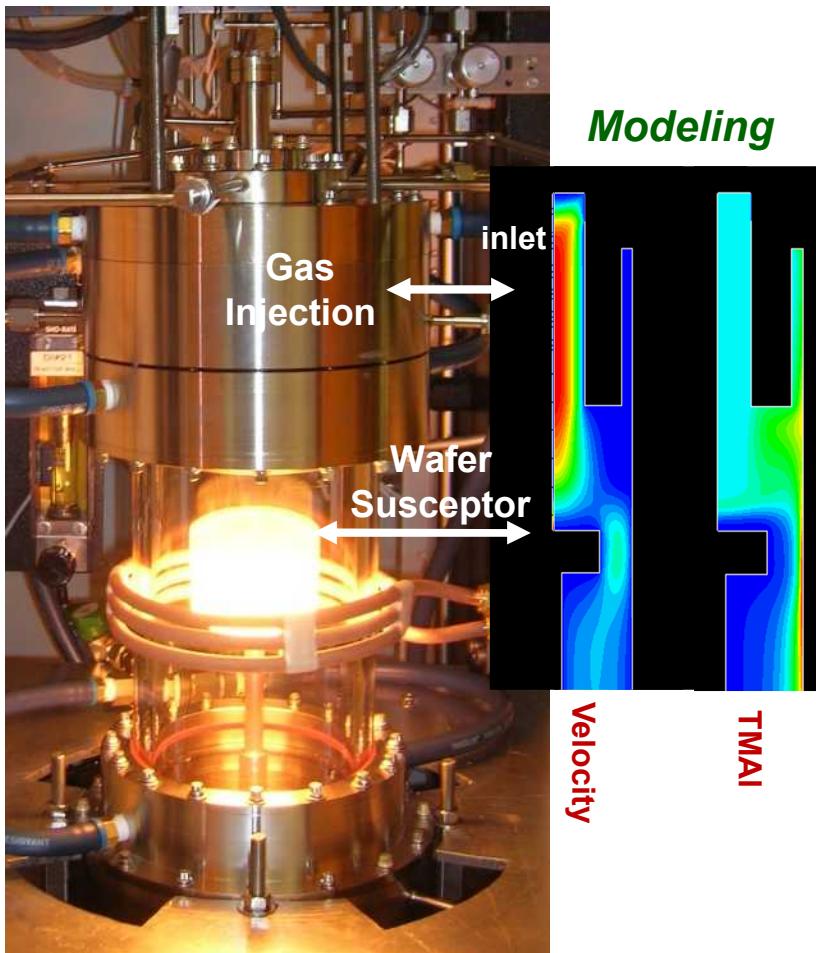


BN Raman peak ratio ($I_{\text{BN}}/I_{\text{sapp}}$) vs. Pulse Cycles



High Temperature MOVPE

>1800°C Operation

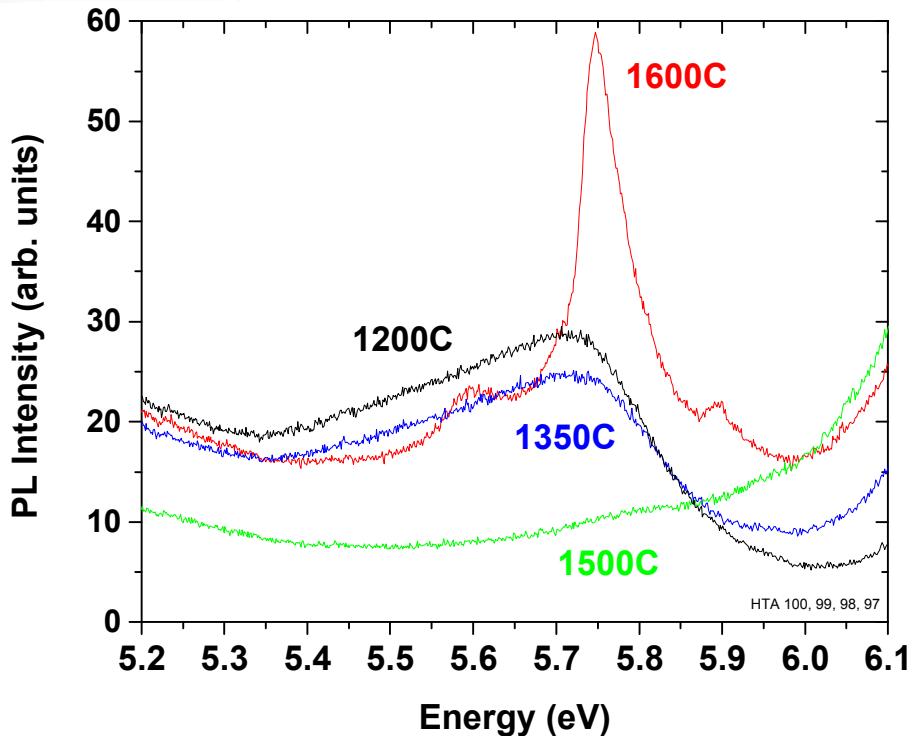


- **Advantages of HT growth**
 - Increased surface mobility of Group-III atoms.
- **Continuous Growth (TEB + NH₃)**
 - Temperature: 1200 – **1600** - 1800°C
 - Pressure: 50 torr
 - NH₃: 0.1 – 2 - 5 slpm
 - TEB: **12** μ moles/min
 - Carrier gas: **N₂**
 - H₂: **0** – 5 slpm
 - Pulsed growth process is being developed

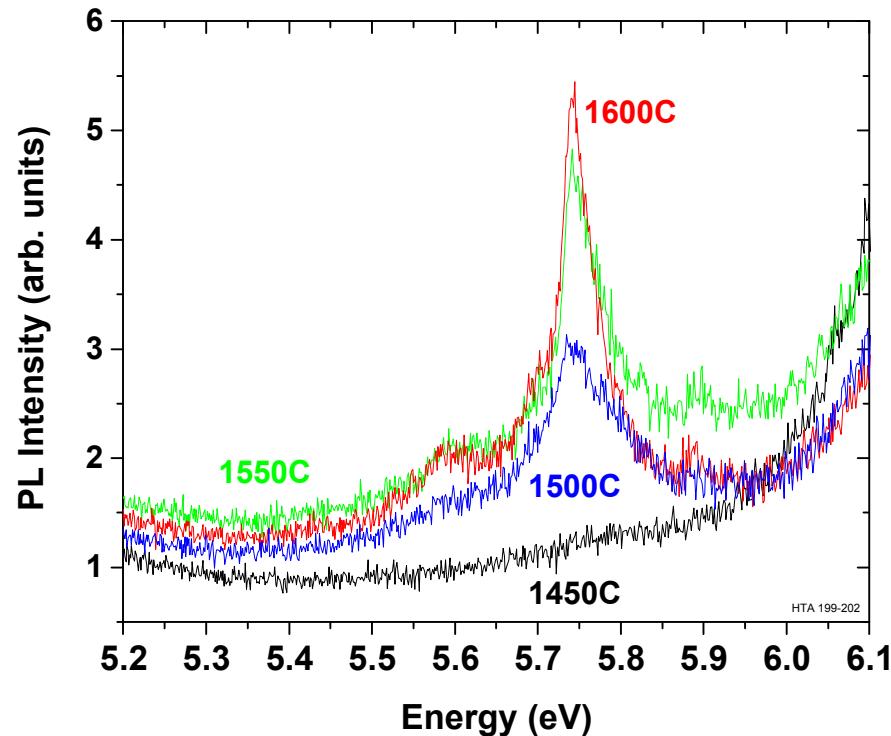
Reactor Design from Prof. Zlatko Sitar (NC State)

Growth Temperature Study: PL

Wide Temp Range: $T_g = 1200\text{-}1600^\circ\text{C}$



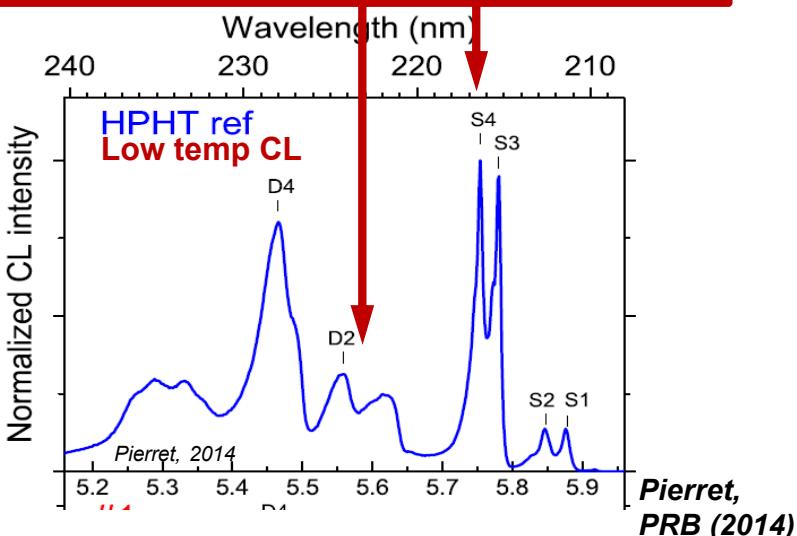
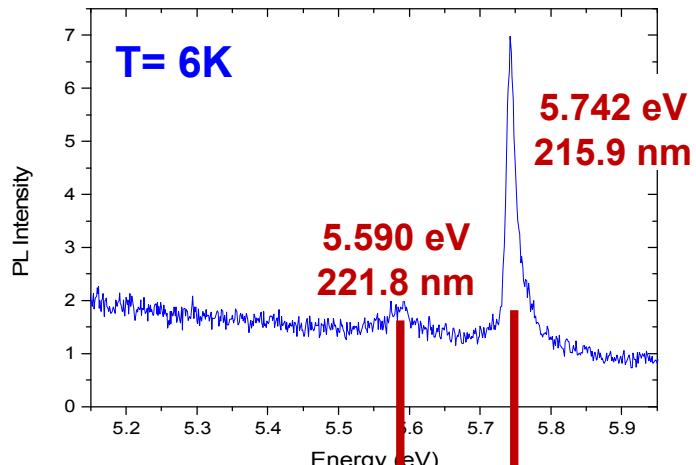
Transition Region: $T_g = 1450\text{-}1600^\circ\text{C}$



- Unusual evolution of near-band-edge features with increasing growth temperature
- Transition to sharp higher-energy free-exciton peak at $T_g \sim 1500\text{-}1600^\circ\text{C}$

Low-Temperature Luminescence: comparisons

MOVPE hBN: $T_g = 1600^\circ\text{C}$

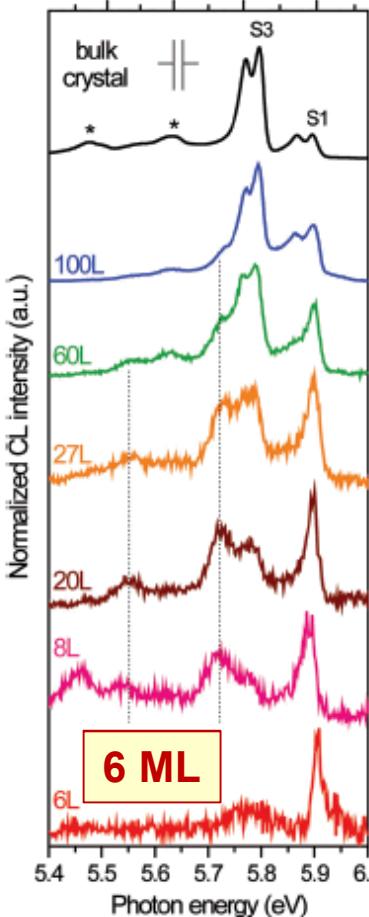


High-Pressure/High-Temperature hBN Crystal

Best Exfoliated hBN Flakes

Low Temp CL

Wavelength (nm)
225 220 215 210

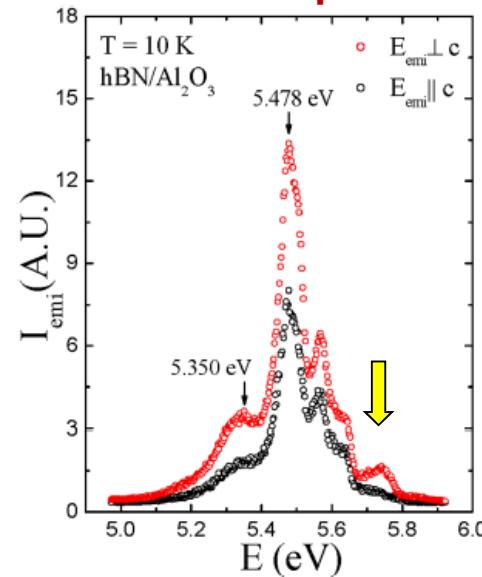


Schue, Nanoscale (2016)

MOVPE hBN

$T_g = 1300^\circ\text{C}$,
1 μm thick

Low Temp PL

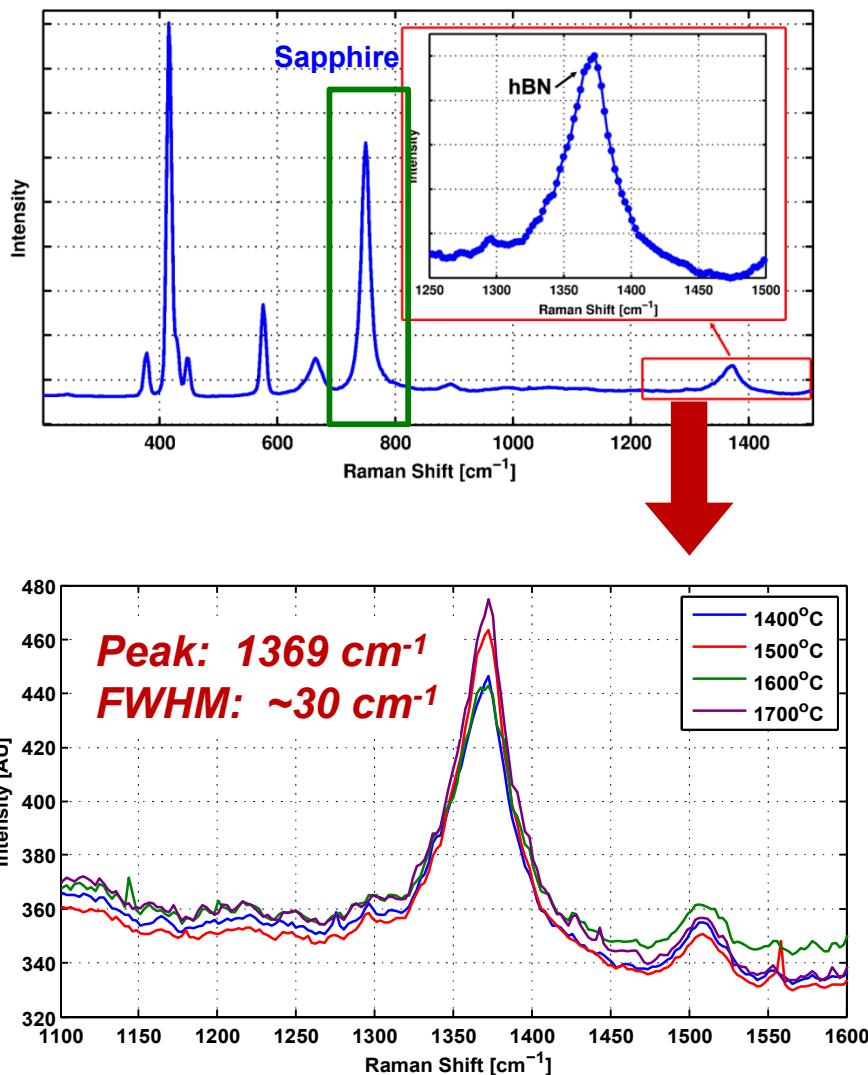


Majety, APL 2012

→ Excitonic signatures of high- T_g MOVPE hBN similar to that of best exfoliated crystals

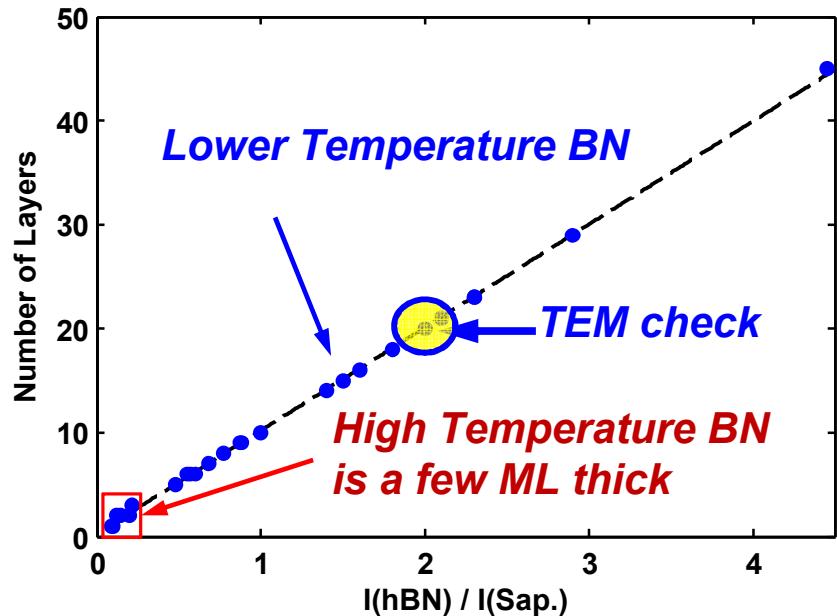
Estimation of Thickness of high- T_g hBN Films

Typical Raman Spectrum



BN Raman peak ratio (I_{BN}/I_{Sapp}) vs. Pulse Cycles

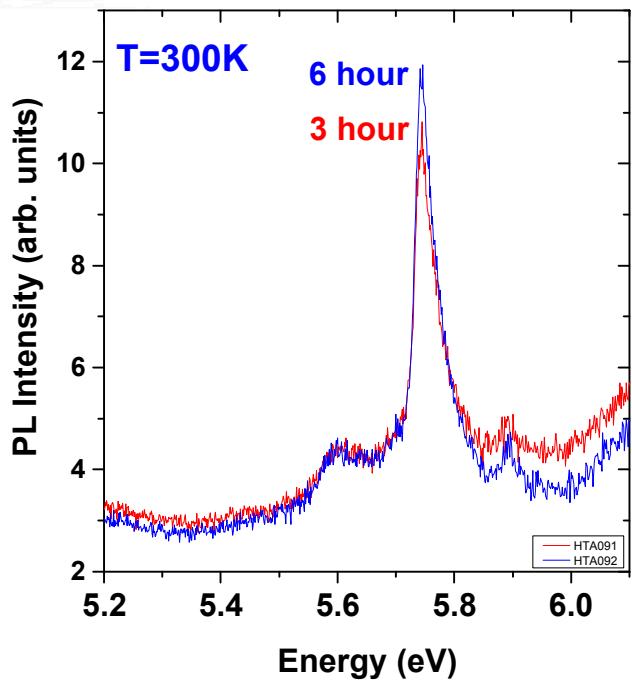
→ Apply calibration from thicker films



- Raman peak is comparable to published reports, little dependence on growth temperature $\geq 1400^{\circ}\text{C}$
- BN film appears to be very thin, 1-2 monolayers

Potential for Self-limiting Growth at high T_g

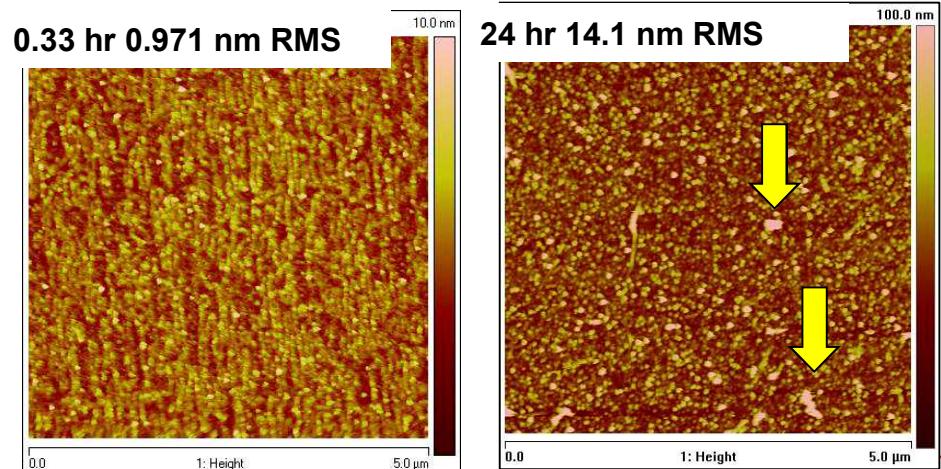
PL Measurements



Results from Raman Measurements

Growth Temp (°C)	Growth Time (hrs)	Raman peak ratio	STEM calibration (MLs)
1600	0.25	0.1	~1
1600	3	0.09	~1
1600	3	0.18	~2
1600	6	0.16	~2
1600	24	0.26	~3

AFM Measurements



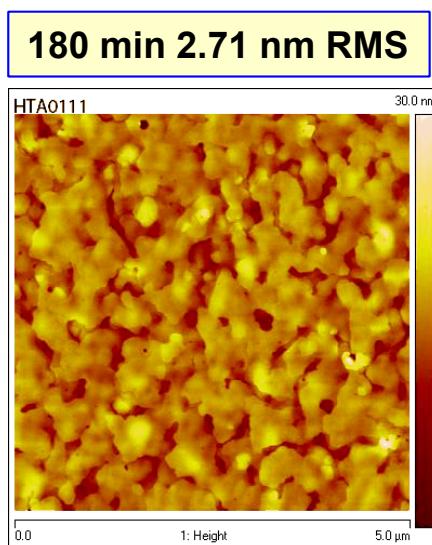
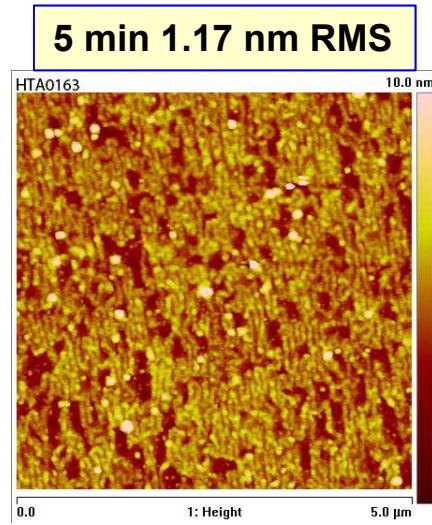
- Relatively little change in PL intensity over a large range of growth times
- Raman ratio (hBN/Sapphire) suggests only a few MLs even for 24 hours of growth
- Films roughen, with increased number of larger particulates, with longer growth times

Challenge with High Temp Growth: Nitridization of Sapphire Substrate

Nitrided Sapphire Substrate

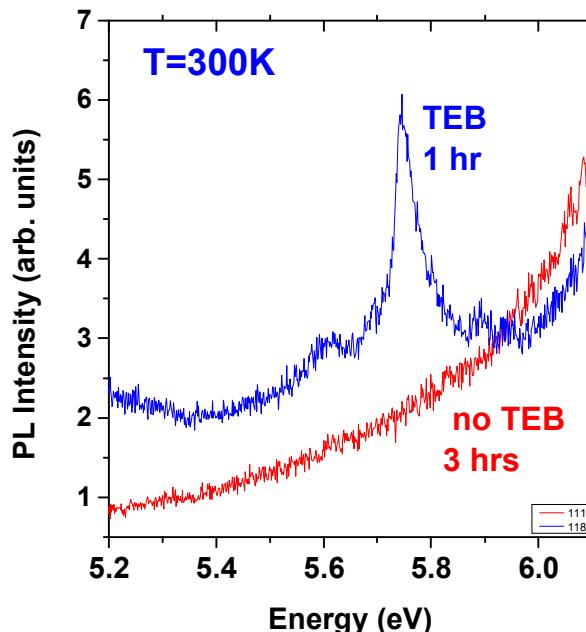
1600°C growth conditions but

No Boron Source Material (TEB)

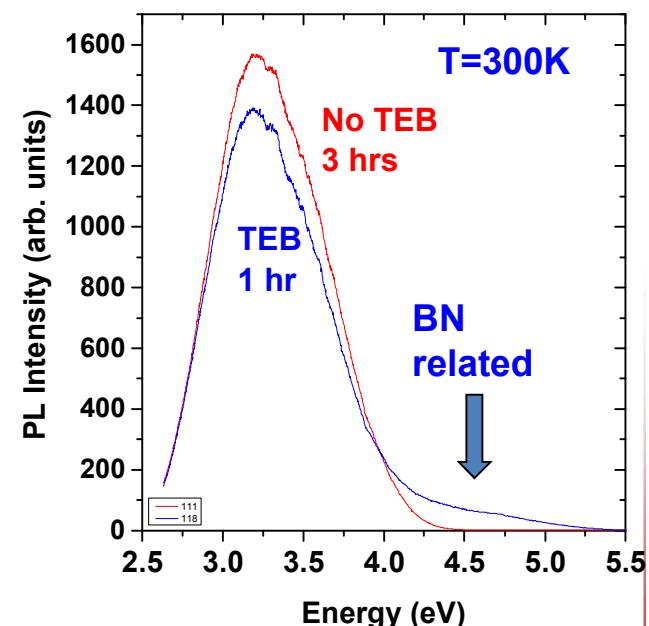


PL comparison: BN on Sapphire vs. Nitrided Sapphire

Near Band Edge



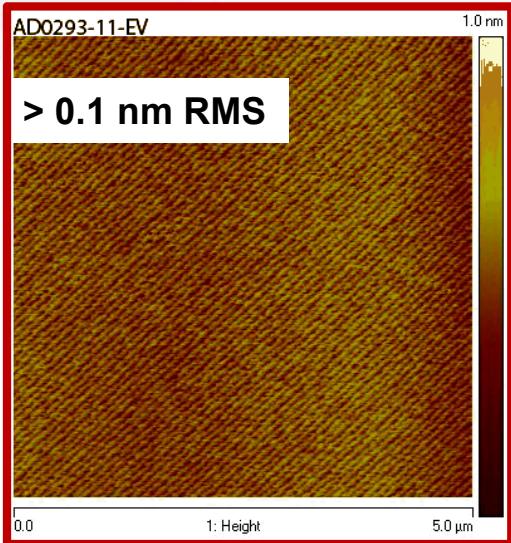
Deep Level



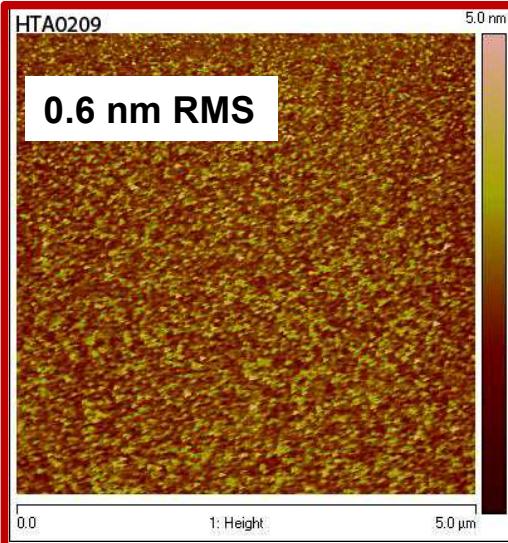
- High temperature NH_3 exposure causes nitridization of sapphire surface (AlN peak seen by Raman)
- Lower crystalline quality than original sapphire, impacts BN morphology
- Contributes strong deep level emission at ~ 3.1 eV

Alternative Substrates: SiC

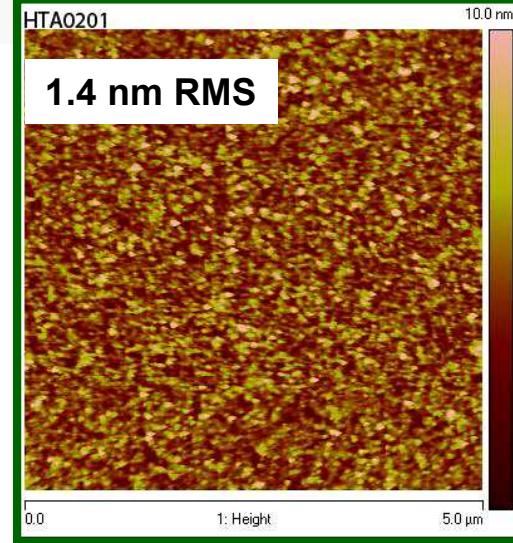
As-received SiC



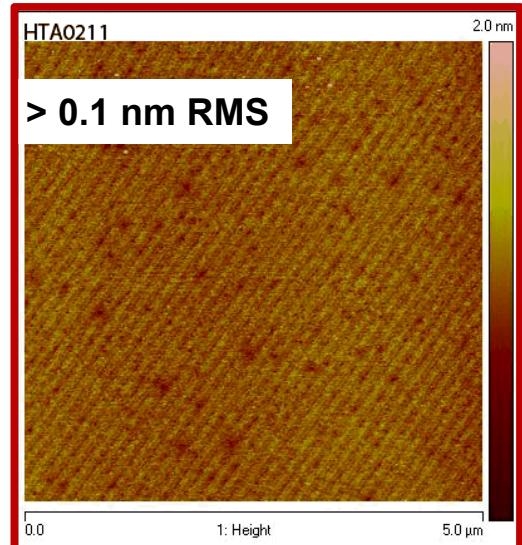
1600°C BN on SiC



1600°C BN on Sapphire



1600°C NH₃ treatment, no TEB



Tg (°C)	RMS roughness (nm)
1400	0.7
1500	0.4
1600	0.6

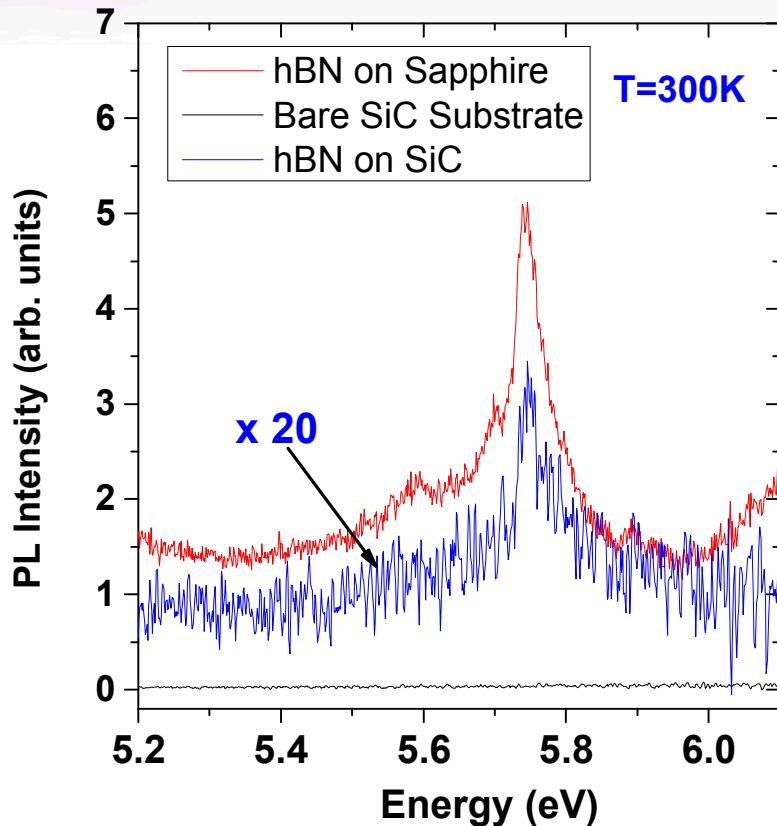
Growth Conditions: 50 Torr, 25 sccm TEB, 2 SLM NH₃, 1 hour

- SiC surface relatively stable with NH₃ exposure
- BN roughness improved over sapphire

hBN on SiC: Luminescence Properties

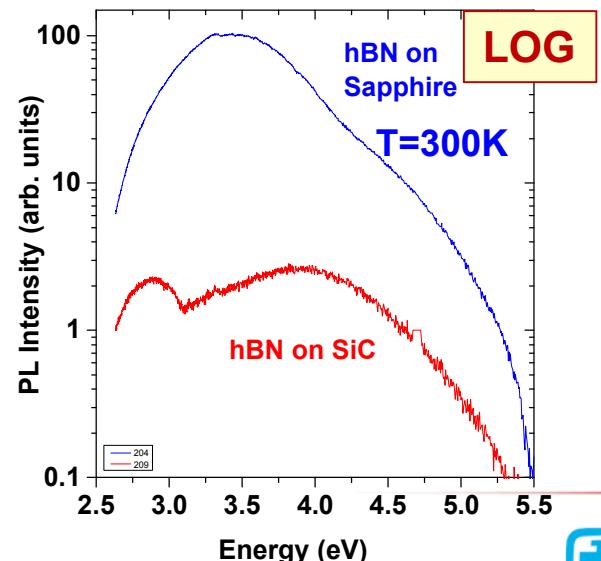
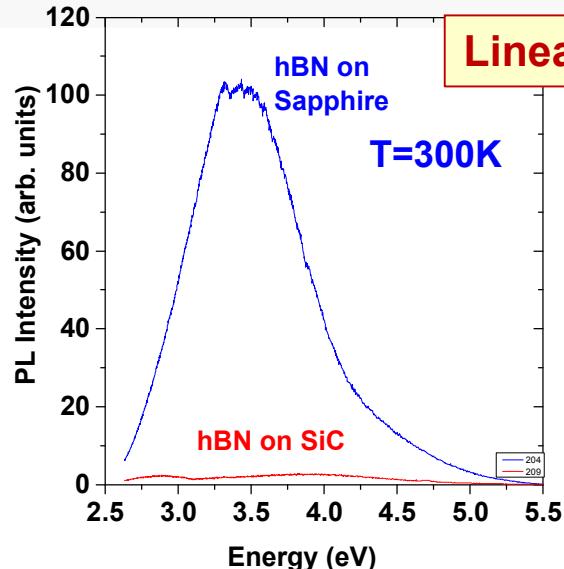
Near Band Edge PL

$T_g = 1600^\circ\text{C}$



- Weak ~216 nm peak in 1st - generation samples
- Elimination of deep level peak associated with nitrided sapphire

Deep Level Emission



Summary

- Explored high- T_g MOVPE as an approach to achieving high-quality, few-ML-thick hBN films
- Determined that lower- T_g films (pulsed growth) demonstrated notable in-plane rotational disorder and defect-related excitonic signatures
- Observed a dramatic evolution of excitonic properties with T_g ; $T_g \sim 1600^\circ\text{C}$ yielded strong free exciton features similar to best exfoliated crystals
- Identified potential for highly-controlled, self-limiting growth of few ML thickness at high- T_g (estimated by Raman spectroscopy)
- Noted challenges with high T_g growth on sapphire, nitridization impacting morphology and deep level PL of hBN
- Presented initial results of hBN on SiC, showing promise for improved structural quality and relatively low defect-related emission

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